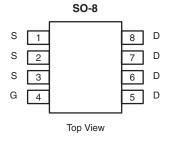


Vishay Siliconix

N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)				
30	0.0115 at V _{GS} = 10 V	12 ^e	13.7 nC				
30	0.0145 at V _{GS} = 4.5 V	12 ^e	13.7 110				



Ordering Information: Si4646DY-T1-E3 (Lead (Pb)-free)

Si4646DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
- SkyFET® Monolithic TrenchFET® Power MOSFET and Schottky Diode
- 100 % R_a and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

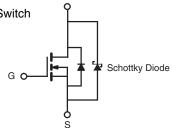


COMPLIANT **HALOGEN**

FREE

APPLICATIONS

- Notebook PC
 - System Power
- **Buck Converter**
- Synchronous Rectifier Switch



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	30	V		
Gate-Source Voltage	V_{GS}	± 20	V		
	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 70 ^{\circ}{\rm C}$		12 ^e 12 ^e		
Continuous Drain Current (T _J = 150 °C)	$T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	- I _D	12 ^{b, c} 9.5 ^{b, c}		
Pulsed Drain Current		I _{DM}	50	Α	
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I _S	5.6 2.7 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	20	mJ	
	T _C = 25 °C		6.25		
Maximum Power Dissipation	$T_C = 70 ^{\circ}C$	P _D	4.0	w	
maximum Foroi Dioopanon	T _A = 25 °C	ט -	3.0 ^{b, c}	• • • • • • • • • • • • • • • • • • • •	
	T _A = 70 °C		1.9 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Тур.	Max.	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	16	20	0/11		

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 90 °C/W.
- e. Package limited.

Si4646DY

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Parameter	Symbol	erwise noted Test Conditions	Min.	Тур.	Max.	Unit	
Static	Зуппоот	rest conditions	IVIIII.	тур.	IVIAX.	Oilit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 1 mA					
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
<u> </u>		V _{DS} = 30 V, V _{GS} = 0 V		0.035	0.2		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 100 °C		3.5	35	mA	
On -State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A		0.0092	0.0115	Ω	
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0115	0.0145		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		38		S	
Dynamic ^b		1		l	<u>l</u>		
Input Capacitance	C _{iss}			1790			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		310		pF	
Reverse Transfer Capacitance	C _{rss}	1		130			
Total Gate Charge	0.	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		30	45	nC	
Total Gate Charge	Qg			13.7	21		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		5			
Gate-Drain Charge	Q_{gd}			4			
Gate Resistance	R_{g}	f = 1 MHz	0.3	1.2	2.4	Ω	
Turn-On Delay Time	t _{d(on)}			23	45		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		13	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		29	55		
Fall Time	t _f			12	24	ns	
Turn-On Delay Time	t _{d(on)}			11	22	115	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		22	45		
Fall Time	t _f			8	16		
Drain-Source Body Diode and Schottky	Characteris						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.6	Α	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V_{SD}	I _S = 2 A		0.53	0.7	V	
Body Diode Reverse Recovery Time	t _{rr}			17	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	- I _F = 10 A, dl/dt = 100 A/μs, T _{.I} = 25 °C -		5.5	10	nC	
Reverse Recovery Fall Time	t _a	- 10 Λ, αναι – 100 Λ/μο, 1 ₁ – 25 0		8		ne	
Reverse Recovery Rise Time	t _b			9		ns	

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

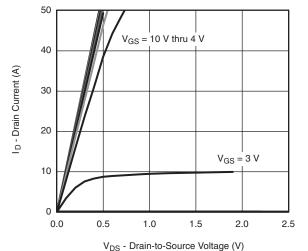
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





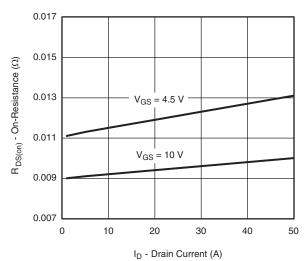
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

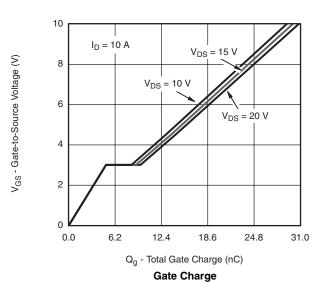


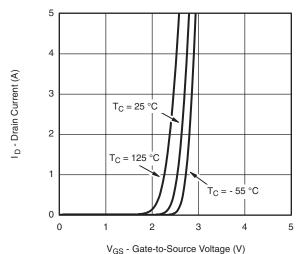
VDS - Diam-to-Source voltage (V)





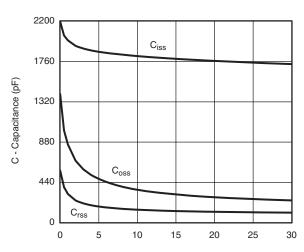
On-Resistance vs. Drain Current





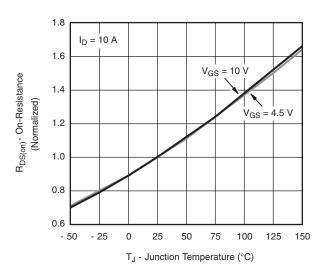
VGS date to bourse voltage (V)





V_{DS} - Drain-to-Source Voltage (V)

Capacitance



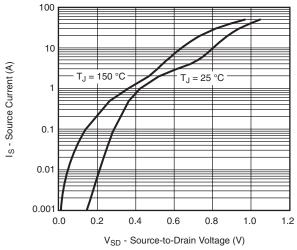
On-Resistance vs. Junction Temperature

Si4646DY

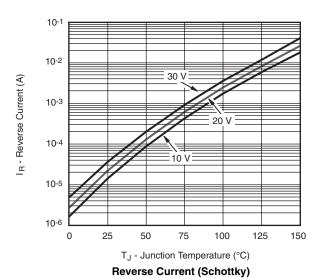
Vishay Siliconix

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

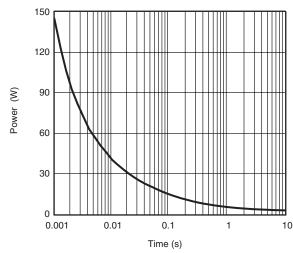


Source-Drain Diode Forward Voltage

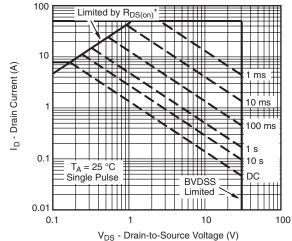


V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



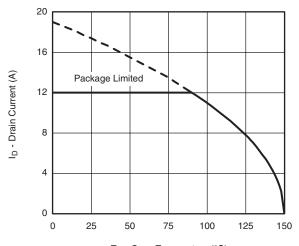
* $V_{GS} > \mbox{ minimum } V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area



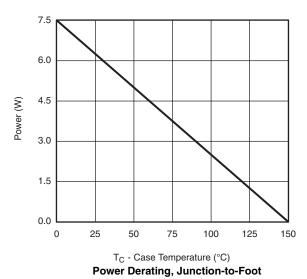
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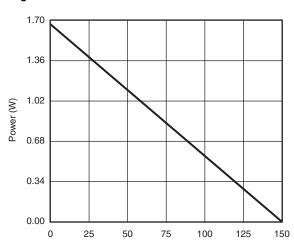
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





T_A - Ambient Temperature (°C) **Power Derating, Junction-to-Ambient**

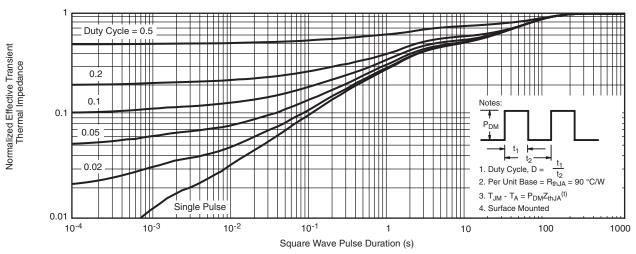
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4646DY

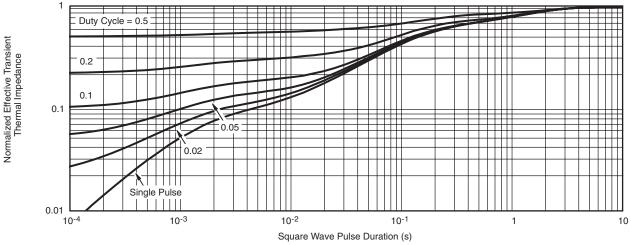
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

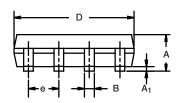
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES				
DIM	Min	Max	Min	Max			
Α	1.35	1.75	0.053	0.069			
A ₁	0.10	0.20	0.004	0.008			
В	0.35	0.51	0.014	0.020			
С	0.19	0.25	0.0075	0.010			
D	4.80	5.00	0.189	0.196			
Е	3.80	4.00	0.150	0.157			
е	1.27	BSC	0.050) BSC			
Н	5.80	6.20	0.228	0.244			
h	0.25	0.50	0.010	0.020			
L	0.50	0.93	0.020	0.037			
q	0°	8°	0°	8°			
S	0.44	0.64	0.018	0.026			
FCN: C-0652	FCN: C-06527-Bey 1 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06 www.vishay.com



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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